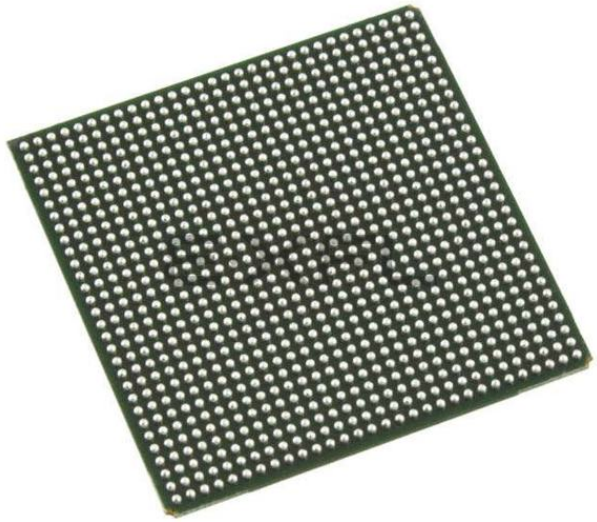


Welcome to E-XFL.COM

Understanding Embedded - FPGAs (Field Programmable Gate Array)

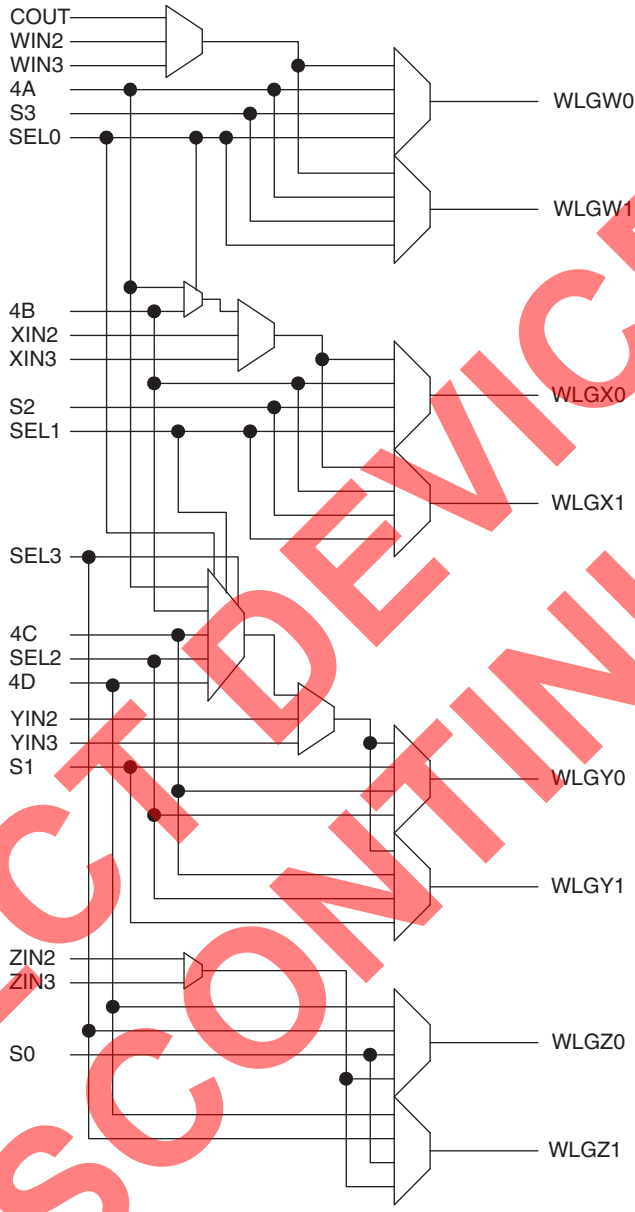
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	15376
Total RAM Bits	423936
Number of I/O	496
Number of Gates	1250000
Voltage - Supply	2.3V ~ 3.6V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	900-BBGA
Supplier Device Package	900-FPBGA (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfx1200eb-05f900c

Figure 6. ispXPGA Wide Logic Generator



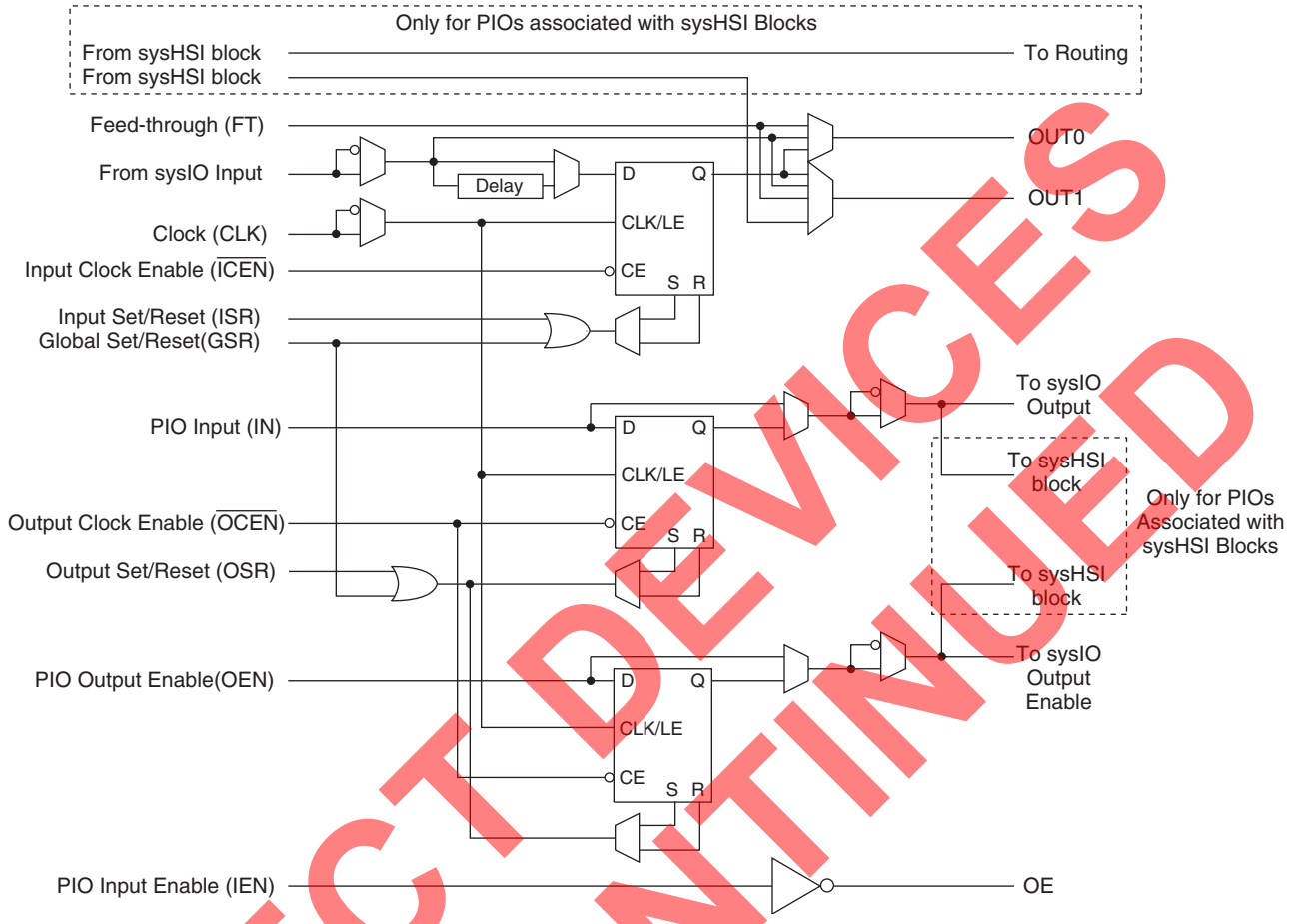
Configurable Sequential Element

There are two registers in each CSE for a total of eight registers in each PFU. This high register count assists in implementing efficient pipelined applications with no utilization penalty. Each register can be configured as a latch or D type flip-flop with either synchronous or asynchronous set or reset. Figure 2 shows the signals that feed the register's D inputs. Feed-through signals in the architecture ensure that registers are efficiently utilized even if the accompanying LUT is occupied.

Control Logic

The control signals available to the registers in a PFU are Clock, Clock Enable, and Set/Reset. Figure 7 shows the various options available to generate the clock signal. As can be seen, the clock signal is the output of a 12:1 MUX with true and compliment versions available from the 12:1 MUX. Each CSE can chose whether it uses the true or complement form of the clock. Figure 8 shows the Set/Reset selection for each PFU in the ispXPGA. A common

Figure 11. ispXPGA PIO



VLI Routing Resources

The ispXPGA architecture contains a Variable-Length-Interconnect (VLI) routing technology connecting the PFUs, PICs, and EBRs in the device. There are four types of routing resources, Global Lines, Long Lines, General Interconnect, and Local Lines forming the global routing structure. This allows a signal to be routed to any element in the device with the optimal delay.

The Global Lines consist of global clock lines and a global set/reset line. These lines are routed to all elements in the device. They are specifically designed for high speed, predictable timing regardless of fan-out. The global clock lines can also be used as dedicated inputs.

The Long Lines consist of Horizontal and Vertical Long Lines (HLL and VLL). The VLL and HLL are tri-statable lines spanning the entire device. These lines allow fast routing for high fan-out nets and general-purpose functions.

The General Interconnect consists of Double and Deca Lines. The Double Lines connect up to three elements (two plus the driving element), while the Deca Lines connect up to eleven elements (ten plus the driving element).

The Local Lines are extremely fast routing paths consisting of Feedback and Direct Connect Lines. The Feedback Lines are internal routing paths from the PFU outputs to the PFU inputs. The Direct Connect Lines connect all adjacent elements.

The Common Interface Block (CIB) provides the link between the logic element (PFU, PIC, or EBR) and the VLI Routing resources. The CIB is a switch matrix that can be programmed to connect virtually any routing resource to any input or output of the logic element.

pattern by a device programmer, securing proprietary designs from competitors. The entire device must be erased in order to erase the security scheme.

Density Shifting

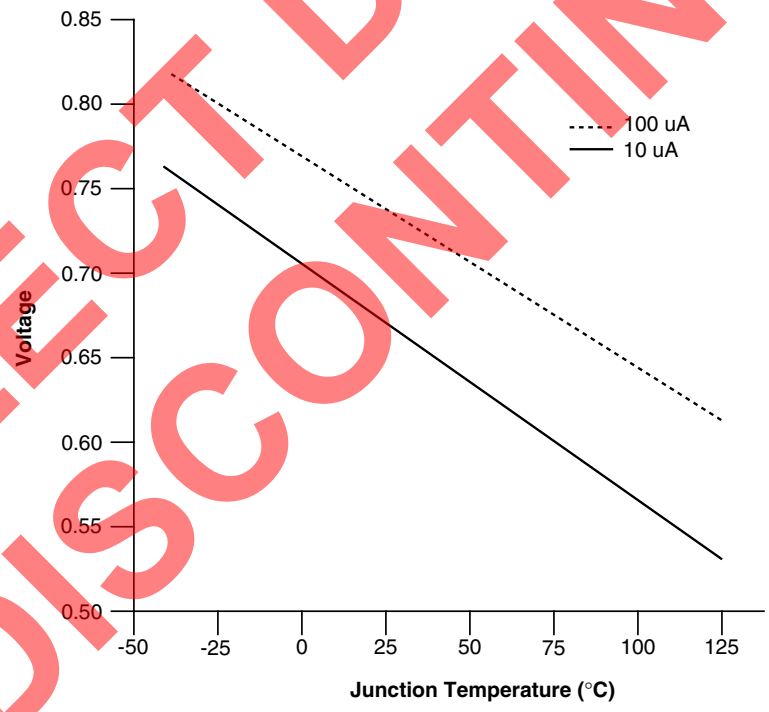
The ispXPGA family has been designed to ensure that different density devices in the same package have the same pin-out. Furthermore, the architecture ensures a high success rate when performing design migration from lower density parts to higher density parts. In many cases, it is possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likely success in each case.

Temperature Sensing Diode

The built-in temperature-sensing diodes allow junction temperature to be measured during device operation. A pair of pins (DXp and DXn) are dedicated for monitoring device junction temperature. The measurement is done by forcing 10 µA and 100 µA current in the forward direction, and then measuring the resulting voltage. The voltage decreases with increasing temperature at approximately 1.64 mV/°C. A typical device with a 85°C junction temperature will measure approximately 593 mV.

The temperature-sensing diode works for the entire operating range as shown in Figure 22 - Sensing Diode Voltage-Temperature Relationship. Refer to the Lattice Thermal Management document for thermal coefficients. Also refer to TN1043, Power Estimation in ispXPGA Devices.

Figure 22. Sensing Diode Voltage-Temperature Relationship



ispXPGA 200B/C & ispXPGA 200EB/EC PFU Timing Parameters (Cont.)

Over Recommended Operating Conditions

Parameter	Description	-5[1]		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Reset/Set								
t_{LASSRO}	Asynchronous Set/Reset to Output	—	1.09	—	1.17	—	1.35	ns
$t_{LASSRPW}$	Asynchronous Set/Reset Pulse Width	4.19	—	4.50	—	5.18	—	ns
t_{LASSRR}	Asynchronous Set/Reset Recovery	—	0.51	—	0.55	—	0.63	ns
t_{LSSR_S}	Synchronous Set/Reset Setup Time	-0.03	—	-0.03	—	-0.03	—	ns
t_{LSSR_H}	Synchronous Set/Reset Hold Time	0.03	—	0.03	—	0.03	—	ns

1. Only available for ispXPGA 200B and ispXPGA 200EB (2.5V/3.3V) devices.
2. $t_{LCTHRUL}$ quoted bit by bit.

Timing v.0.3

ispXPGA 200B/C & ispXPGA 200EB/EC PIC Timing Parameters

Parameter	Description	-5[1]		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Register/Latch Delays								
t_{IO_CO}	Register Clock to Output Delay	—	0.93	—	1.00	—	1.15	ns
t_{IO_S}	Register Setup Time (Data before Clock)	0.05	—	0.05	—	0.06	—	ns
t_{IO_H}	Register Hold Time (Data after Clock)	0.06	—	0.06	—	0.07	—	ns
t_{IOCE_S}	Register Clock Enable Setup Time	-0.03	—	-0.03	—	-0.03	—	ns
t_{IOCE_H}	Register Clock Enable Hold Time	0.13	—	0.13	—	0.15	—	ns
t_{IO_GO}	Latch Gate to Output Delay	—	0.72	—	0.77	—	0.89	ns
t_{IOL_S}	Latch Setup Time	0.05	—	0.05	—	0.06	—	ns
t_{IOL_H}	Latch Hold Time	0.06	—	0.06	—	0.07	—	ns
t_{IOLPD}	Latch Propagation Delay (Transparent Mode)	—	0.09	—	0.10	—	0.12	ns
t_{IOASRO}	Asynchronous Set/Reset to Output	—	1.04	—	1.12	—	1.29	ns
$t_{IOASRPW}$	Asynchronous Set/Reset Pulse Width	4.19	—	4.50	—	5.18	—	ns
t_{IOASRR}	Asynchronous Set/Reset Recovery Time	—	0.23	—	0.25	—	0.29	ns
Input/Output Delays								
t_{IOBUF}	Output Buffer Delay	—	0.97	—	1.04	—	1.20	ns
t_{IOIN}	Input Buffer Delay	—	0.60	—	0.64	—	0.74	ns
t_{IOEN}	Output Enable Delay	—	0.53	—	0.57	—	0.66	ns
t_{IODIS}	Output Disable Delay	—	-0.13	—	-0.12	—	-0.10	ns
t_{IOFT}	Feed-thru Delay	—	0.19	—	0.20	—	0.23	ns

1. Only available for ispXPGA 200B and ispXPGA 200EB (2.5V/3.3V) devices.

Timing v.0.3

ispXPGA 200B/C & ispXPGA 200EB/EC Timing Adders

Parameter	Description	Base Parameter	-5[1]		-4		-3		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
Optional Adders									
$t_{IOINDLY}$	Input Delay	—	—	4.84	—	5.2	—	5.98	ns
t_{IOI} Input Adjusters									
LVTTL_in	Using 3.3V TTL	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_18_in	Using 1.8V CMOS	t_{IOIN}	—	0.0	—	0.0	—	0.0	ns
LVCMOS_25_in	Using 2.5V CMOS	t_{IOIN}	—	0.3	—	0.3	—	0.3	ns
LVCMOS_33_in	Using 3.3V CMOS	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
AGP_1X_in	Using AGP 1x	t_{IOIN}	—	1.0	—	1.0	—	1.0	ns
CTT25_in	Using CTT 2.5V	t_{IOIN}	—	1.0	—	1.0	—	1.0	ns
CTT33_in	Using CTT 3.3V	t_{IOIN}	—	1.0	—	1.0	—	1.0	ns
GTL+_in	Using GTL+	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
HSTL_I_in	Using HSTL 2.5V, Class I	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
HSTL_III_in	Using HSTL 2.5V, Class III	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
LVDS_in	Using Low Voltage Differential Signaling (LVDS)	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
BLVDS_in	Using Bus Low Voltage Differential Signaling (BLVDS)	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
LVPECL_in	Using Low Voltage PECL	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
PCI_in	Using PCI	t_{IOIN}	—	1.0	—	1.0	—	1.0	ns
SSTL2_I_in	Using SSTL 2.5V, Class I	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
SSTL2_II_in	Using SSTL 2.5V, Class II	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_in	Using SSTL 3.3V, Class I	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
SSTL3_II_in	Using SSTL 3.3V, Class II	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
t_{IOO} Output Adjusters									
Slow Slew	Using Slow Slew (LVTTL and LVCMOS Outputs only)	t_{IOBUF}, t_{IOEN}	—	0.7	—	0.7	—	0.7	ns
LVTTL_out	Using 3.3V TTL Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	1.0	—	1.0	—	1.0	ns
LVCMOS_18_4mA_out	Using 1.8V CMOS Standard, 4mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.8	—	0.8	—	0.8	ns
LVCMOS_18_5.33mA_out	Using 1.8V CMOS Standard, 5.33mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.6	—	0.6	—	0.6	ns
LVCMOS_18_8mA_out	Using 1.8V CMOS Standard, 8mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.0	—	0.0	—	0.0	ns
LVCMOS_18_12mA_out	Using 1.8V CMOS Standard, 12mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.2	—	0.2	—	0.2	ns
LVCMOS_25_4mA_out	Using 2.5V CMOS Standard, 4mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.7	—	0.7	—	0.7	ns
LVCMOS_25_5.33mA_out	Using 2.5V CMOS Standard, 5.33 mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_25_8mA_out	Using 2.5V CMOS Standard, 8mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_25_12mA_out	Using 2.5V CMOS Standard, 12mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_25_16mA_out	Using 2.5V CMOS Standard, 16mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns

ispXPGA 500B/C & ispXPGA 500EB/EC Timing Adders (Cont.)

Parameter	Description	Base Parameter	-5[1]		-4		-3		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
LVCMOS_33_4mA_out	Using 3.3V CMOS Standard, 4mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	1.0	—	1.0	—	1.0	ns
LVCMOS_33_5.33mA_out	Using 3.3V CMOS Standard, 5.33mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	1.0	—	1.0	—	1.0	ns
LVCMOS_33_8mA_out	Using 3.3V CMOS Standard, 8mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.7	—	0.7	—	0.7	ns
LVCMOS_33_12mA_out	Using 3.3V CMOS Standard, 12mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_33_16mA_out	Using 3.3V CMOS Standard, 16mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_33_24mA_out	Using 3.3V CMOS Standard, 24mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
AGP_1X_out	Using AGP 1x Standard	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
CTT25_out	Using CTT 2.5V	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
CTT33_out	Using CTT 3.3V	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
GTL+_out	Using GTL+	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
HSTL_I_out	Using HSTL 2.5V, Class I	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
HSTL_III_out	Using HSTL 2.5V, Class III	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVDS_out	Using Low Voltage Differential Signaling (LVDS)	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	1.0	—	1.0	—	1.0	ns
BLVDS_out	Using Bus Low Voltage Differential Signaling (BLVDS)	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	1.0	—	1.0	—	1.0	ns
LVPECL_out	Using Low Voltage PECL	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	1.0	—	1.0	—	1.0	ns
PCI_out	Using PCI Standard	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
SSTL2_I_out	Using SSTL 2.5V, Class I	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
SSTL2_II_out	Using SSTL 2.5V, Class II	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_out	Using SSTL 3.3V, Class I	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
SSTL3_II_out	Using SSTL 3.3V, Class II	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns

1. Only available for ispXPGA 500B and ispXPGA 500EB (2.5V/3.3V) devices.

Timing v.0.3

ispXPGA 1200B/C & ispXPGA 1200EB/EC PFU Timing Parameters

Over Recommended Operating Conditions

Parameter	Description	-5[1]		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Functional Delays								
LUTs								
t_{LUT4}	4-Input LUT Delay	—	0.41	—	0.44	—	0.51	ns
t_{LUT5}	5-Input LUT Delay	—	0.73	—	0.79	—	0.91	ns
t_{LUT6}	6-Input LUT Delay	—	0.86	—	0.93	—	1.07	ns
Shift Register (LUT)								
t_{LSR_S}	Shift Register Setup Time	-0.64	—	-0.62	—	-0.53	—	ns
t_{LSR_H}	Shift Register Hold Time	0.61	—	0.63	—	0.72	—	ns
t_{LSR_CO}	Shift Register Clock to Output Delay	—	0.70	—	0.75	—	0.86	ns
Arithmetic Functions								
$t_{LCTHRUR}$	MC (Macro Cell) Carry In to MC Carry Out Delay (Ripple)	—	0.08	—	0.09	—	0.10	ns
$t_{LCTHRUL}$[2]	MC Carry In to MC Carry Out Delay (Look Ahead)	—	0.05	—	0.05	—	0.06	ns
t_{LSTHRU}	MC Sum In to MC Sum Out Delay	—	0.42	—	0.45	—	0.52	ns
$t_{LSINCOUT}$	MC Sum In to MC Carry Out Delay	—	0.29	—	0.31	—	0.36	ns
$t_{LCINSOUTR}$	MC Carry In to MC Sum Out Delay (Ripple)	—	0.36	—	0.39	—	0.45	ns
$t_{LCINSOUTL}$	MC Carry In to MC Sum Out Delay (Look Ahead)	—	0.26	—	0.28	—	0.32	ns
Feed-thru								
t_{LFT}	PFU Feed-Thru Delay	—	0.15	—	0.16	—	0.18	ns
Distributed RAM								
t_{LRAM_CO}	Clock to RAM Output	—	1.24	—	1.33	—	1.53	ns
t_{LRAMAD_S}	Address Setup Time	-0.41	—	-0.40	—	-0.34	—	ns
t_{LRAMD_S}	Data Setup Time	0.21	—	0.22	—	0.25	—	ns
t_{LRAMWE_S}	Write Enable Setup Time	0.45	—	0.46	—	0.53	—	ns
t_{LRAMAD_H}	Address Hold Time	0.58	—	0.60	—	0.69	—	ns
t_{LRAMD_H}	Data Hold Time	0.11	—	0.11	—	0.13	—	ns
t_{LRAMWE_H}	Write Enable Hold Time	0.12	—	0.12	—	0.14	—	ns
$t_{LRAMCPW}$	Clock Pulse Width (High or Low)	2.91	—	3.00	—	3.45	—	ns
$t_{LRAMADO}$	Address to Output Delay	—	0.86	—	0.93	—	1.07	ns
Register/Latch Delays								
Registers								
t_{L_CO}	Register Clock to Output Delay	—	0.58	—	0.62	—	0.71	ns
t_{L_S}	Register Setup Time (Data before Clock)	0.14	—	0.14	—	0.16	—	ns
t_{L_H}	Register Hold Time (Data after Clock)	-0.12	—	-0.12	—	-0.10	—	ns
t_{LCE_S}	Register Clock Enable Setup Time	-0.11	—	-0.11	—	-0.09	—	ns
t_{LCE_H}	Register Clock Enable Hold Time	0.11	—	0.11	—	0.13	—	ns
Latches								
t_{L_GO}	Latch Gate to Output Delay	—	0.09	—	0.10	—	0.12	ns
t_{LL_S}	Latch Setup Time	0.14	—	0.14	—	0.16	—	ns
t_{LL_H}	Latch Hold Time	-0.12	—	-0.12	—	-0.10	—	ns
t_{LLPD}	Latch Propagation Delay (Transparent Mode)	—	0.09	—	0.10	—	0.12	ns

REFCLK and SS_CLKIN Timing

Symbol	Description	Mode	Condition	Min	Max	Unit
$t_{DREFCLK}$	Frequency Deviation Between TX REFCLK and CDRX REFCLK on One Link	8B10B/ 10B12B		-100	100	ppm
$t_{JPPREFCLK}$	REFCLK, SS_CLKIN Peak-to-Peak Period Jitter	All	Random Jitter		0.01	UIPP
$t_{PWREFCLK}$	REFCLK, SS_CLKIN Pulse Width, (80% to 80% or 20% to 20%).	All	40-100MHz	2		ns
			100-200MHz	1		
$t_{RFREFCLK}$	REFCLK, SS_CLKIN Rise/Fall Time (20% to 80% or 80% to 20%)	All			2	ns

Serializer Timing[2]

Symbol	Description	Mode	Condition	Min	Max	Unit
$t_{JPPSOUT}$	SOUT Peak-to-Peak Output Data Jitter	All	f_{CLK} with no jitter		0.25	UIPP
$t_{JPP8B10B}$	SOUT Peak-to-Peak Random Jitter	8B10B	800 Mbps w/K28.7-		130	ps
	SOUT Peak-to-Peak Deterministic Jitter	8B10B	800 Mbps w/K28.5+		160	ps
t_{RFSOUT}	SOUT Output Data Rise/Fall Time (20%, 80%)	LVDS			700	ps
t_{COSOUT}	REFCLK to SOUT Delay	SS/8B10B		$2Bt^{1}$ + 2	$2Bt^{1}$ +10	ns
		10B12B		$1Bt^{1}$ + 2	$1Bt^{1}$ +10	ns
t_{SKTX}	Skew of SOUT with Respect to SS_CLKOUT	SS			300	ps
$t_{CKOSOUT}$	SS_CLKOUT to bit0 of SOUT	SS		$2Bt^{1}$ - t_{SKTX}	$2Bt^{1}$ + t_{SKTX}	ns
$t_{HSITXDDATAS}$	TXD Data Setup Time	All	Note 3	1.5		ns
$t_{HSITXDDATAH}$	TXD Data Hold Time	All	Note 3		1.0	ns

1. Bt: Bit Time Period. High Speed Serial Bit Time.
2. The SIN and SOUT jitter specifications listed above are under the condition that the clock tree that drives the REFCLK to sysHSI Block is in sysCLOCK PLL BYPASS mode.
3. Internal timing for reference only.

Deserializer Timing

Symbol	Description	Mode	Conditions	Min	Max	Units
f_{DSIN}	SIN Frequency Deviation from REFCLK	8B10B/ 10B12B		-100	100	ppm
eo_{SIN}	SIN Eye Opening Tolerance	All	Notes 1, 2	0.45		UIPP
ber	Bit Error Rate	All			10^{-12}	Bits
$t_{HSIOUTVALIDPRE}$	RXD, SYDT Valid Time Before RECCLK Falling Edge	All	Note 3	$t_{RCP}/2$ - 0.7		ns
$t_{HSIOUTVALIDPOST}$	RXD, SYDT Valid Time After RECCLK Falling Edge	All	Note 3	$t_{RCP}/2$ - 0.7		ns
t_{DSIN}	Bit 0 of SIN Delay to RXD Valid at RECCLK Falling edge	All		1.5 t_{RCP} + 4.5Bt + 3	1.5 t_{RCP} + 4.5Bt + 15	ns

1. Eye opening based on jitter frequency of 100KHz.
2. Lower frequency operation assumes maximum eye closure of 800ps.
3. Internal timing for reference only.

sysCLOCK PLL Timing

Over Recommended Operating Conditions

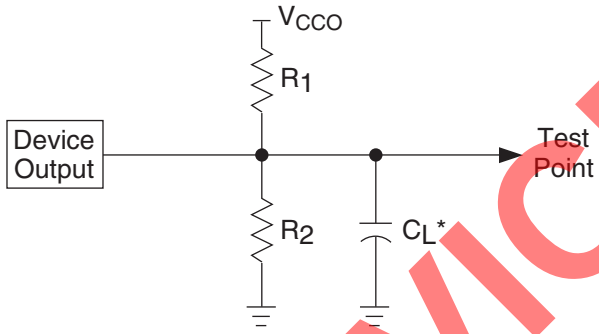
Symbol	Parameter	Conditions	Min	Max	Units
t_{PWH}	Input clock, high time	80% to 80%	1.2	—	ns
t_{PWL}	Input clock, low time	20% to 20%	1.2	—	ns
t_R, t_F	Input Clock, rise and fall time	20% to 80%	—	3.0	ns
t_{INSTB}	Input clock stability, cycle to cycle (peak)		—	+/- 250	ps
f_{MDIVIN}	M Divider input, frequency range		10	320	MHz
$f_{MDIVOUT}$	M Divider output, frequency range		10	320	MHz
f_{NDIVIN}	N Divider input, frequency range		10	320	MHz
$f_{NDIVOUT}$	N Divider output, frequency range		10	320	MHz
f_{VDIVIN}	V Divider input, frequency range		100	400	MHz
$f_{VDIVOUT}$	V Divider output, frequency range		10	320	MHz
$t_{OUTDUTY}$	output clock, duty cycle		40	60	%
$t_{JIT(CC)}$	Output clock, cycle to cycle jitter (peak)	Clean reference[1] 10MHz ð $f_{MDIVOUT}$ ð 40MHz or 100MHz ð f_{VDIVIN} ð 160MHz	—	+/- 600	ps
		Clean reference[1] 40MHz ð $f_{MDIVOUT}$ ð 320MHz and 160MHz ð f_{VDIVIN} ð 400MHz	—	+/- 150	ps
$t_{JIT(PER)}$[2]	Output clock, period jitter (peak)	Clean reference[1] 10MHz ð $f_{MDIVOUT}$ ð 40MHz or 100MHz ð f_{VDIVIN} ð 160MHz	—	+/- 600	ps
		Clean reference[1] 40MHz ð $f_{MDIVOUT}$ ð 320MHz and 160MHz ð f_{VDIVIN} ð 400MHz	—	+/- 150	ps
$t_{CLK\_OUT\_DELAY}$	Input clock to CLK_OUT delay	Internal feedback	—	3.0	ns
t_{PHASE}	Input clock to external feedback delta	External feedback	—	1.5	ns
t_{LOCK}	Time to acquire phase lock after input stable		—	25	us
t_{PLL_DELAY}	Delay increment (Lead/Lag)	Typical = +/- 250ps	+/- 120	+/- 550	ps
t_{RANGE}	Total output delay range (lead/lag)		+/- 0.84	+/- 3.85	ns
t_{PLL_RSTW}	Minimum reset pulse width		1.8	—	ns
t_{CLK_IN}[3]	Global clock input delay		—	1.0	ns
$t_{PLL\_SEC\_DELAY}$	Secondary PLL output delay		—	1.5	ns

1. This condition assures that the output phase jitter will remain within specifications. Jitter spec is based on optimized M, N and V settings determined by the ispLEVER software.
2. Accumulated jitter measured over 10,000 waveform samples
3. Internal timing for reference only.

Switching Test Conditions

Figure 25 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 7.

Figure 25. Output Test Load, LVTTL and LVCMOS Standards



*C_L includes test fixture and probe capacitance.

Table 7. Text Fixture Required Components

Test Condition	R_1	R_2	C_L	Timing Reference	VCCO
LVCMOS I/O, (L -> H, H -> L)	106	106	35pF	LVCMOS 3.3 = V_{CCO}/2	LVCMOS 3.3 = 3.0V
				LVCMOS 2.5 = V_{CCO}/2	LVCMOS 2.5 = 2.3V
				LVCMOS 1.8 = V_{CCO}/2	LVCMOS 1.8 = 1.65V
Default LVCMOS 1.8 I/O (Z -> H)	×	106	35pF	0.9V	1.65V
Default LVCMOS 1.8 I/O (Z -> L)	106	×	35pF	0.9V	1.65V
Default LVCMOS 1.8 I/O (H -> Z)	×	106	5pF	V_{OH} - 0.3	1.65V
Default LVCMOS 1.8 I/O (L -> Z)	106	×	5pF	V_{OL} + 0.3	1.65V

Note: Output test conditions for all other interfaces are determined by the respective standards.

ispXPGA Power Supply and NC Connections[1] (Continued)

Signal	680-Ball fpBGA[3]	900-Ball fpBGA[3]
NC[2]	A3, B29, AW3, AV3, AW11, AV11, AV29, AW29, AW37, B3, AV37, C39, C38, AU39, AU38, AJ39, AJ38, N38, N39, C2, C1, AU1, AU2, AJ2, AJ1, N2, N1, B11, A11, A37, B37, A29	**LFX500:** A8, A9, A10, A11, A19, A20, A21, A22, B8, B9, B10, B11, B19, B20, B21, B22, C1, C2, C11, C12, C19, C20, C23, D3, D10, D11, D12, D19, D20, D21, D22, D23, E3, E5, E6, E10, E11, E12, E21, E22, E25, E26, E28, E29, E30, F1, F2, F6, F9, F10, F11, F12, F21, F22, F25, F26, F29, F30, G1, G2, G3, G4, G7, G8, G9, G10, G11, G12, G14, G15, G16, G17, G19, G20, G21, G22, G23, G24, G25, G26, G27, G28, G29, G30, H1, H2, H3, H4, H5, H6, H7, H8, H9, H10, H11, H12, H13, H14, H15, H16, H17, H18, H19, H20, H21, H22, H23, H24, H27, H28, H29, H30, J1, J2, J4, J5, J6, J7, J8, J9, J10, J11, J12, J13, J14, J15, J16, J17, J18, J19, J20, J21, J22, J23, J24, J25, J26, J27, K6, K7, K8, K9, K10, K12, K13, K14, K15, K16, K17, K18, K19, K21, K22, K23, K24, K25, L7, L8, L9, L22, L23, L24, M7, M8, M9, M10, M21, M22, M23, M24, N8, N9, N10, N21, N22, N23, P7, P8, P9, P10, P21, P22, P23, P24, R8, R9, R10, R21, R22, R23, R24, R25, T6, T7, T8, T9, T10, T21, T22, T23, T24, T25, U7, U8, U9, U10, U21, U22, U23, U24, V8, V9, V10, V21, V22, V23, W7, W8, W9, W10, W21, W22, W23, W24, W25, W26, Y3, Y4, Y5, Y6, Y7, Y8, Y9, Y22, Y23, Y24, Y25, Y26, Y27, Y28, AA4, AA5, AA6, AA7, AA8, AA9, AA10, AA12, AA13, AA14, AA15, AA16, AA17, AA18, AA19, AA21, AA22, AA23, AA24, AA25, AA26, AA27, AB1, AB2, AB4, AB5, AB6, AB7, AB8, AB9, AB10, AB11, AB12, AB13, AB14, AB15, AB16, AB17, AB18, AB19, AB20, AB21, AB22, AB23, AB24, AB25, AB26, AB27, AC1, AC2, AC3, AC4, AC5, AC6, AC7, AC8, AC9, AC10, AC11, AC12, AC13, AC14, AC15, AC16, AC17' AC18' AC19, AC20, AC21, AC22, AC23, AC24, AC27, AC28, AC29, AC30, AD1, AD2, AD7, AD8, AD9, AD10, AD11, AD12, AD14, AD15, AD16, AD17, AD19, AD20, AD21, AD22, AD23, AD24, AD29, AD30, AE6, AE9, AE10, AE11, AE12, AE19, AE20, AE21, AE22, AE25, AE29, AE30, AF5, AF6, AF10, AF11, AF12, AF19, AF20, AF21, AF22, AF25, AF26, AG10, AG11, AG12, AG19, AG20, AG21, AG22, AH11, AH12, AH19, AH20, AJ8, AJ9, AJ10, AJ11, AJ20, AJ21, AJ22, AK8, AK9, AK10, AK11, AK20, AK21, AK22 **LFX1200:** AA22, AA23, AA24, AA25, AB23, AC24, T21, T22, T23, T24, T25, U21, U22, U23, U24, V21, V22, V23, W21, W22, W23, W24, Y22, Y23, Y24, AA16, AA17, AA18, AA19, AA21, AB16, AB17, AB18, AB19, AB20, AB21, AB22, AC16, AC17, AC18, AC19, AC20, AC21, AC22, AC23, AD16, AD17, AD19, AD20, AD22, AD23, AD24, AE22, AE25, AF25, AF26, AA10, AA12, AA13, AA14, AA15, AB10, AB11, AB12, AB13, AB14, AB15, AB9, AC10, AC11, AC12, AC13, AC14, AC15, AC8, AC9, AD11, AD12, AD14, AD15, AD7, AD8, AD9, AE6, AE9, AF5, AF6, H24, J23, K22, K23, K24, K25, L22, L23, L24, M21, M22, M23, M24, N21, N22, N23, P21, P22, P23, P24, R21, R22, R23, R24, R25, AA6, AA7, AA8, AA9, AB8, AC7, T10, T6, T7, T8, T9, U10, U7, U8, U9, V10, V8, V9, W10, W7, W8, W9, Y7, Y8, Y9, H5, H6, H7, J8, K6, K7, K8, K9, L7, L8, L9, M10, M7, M8, M9, N10, N8, N9, P10, P7, P8, P9, R10, R8, R9, E25, E26, F22, F25, G16, G17, G19, G20, G22, G23, G24, H16, H17, H18, H19, H20, H21, H22, H23, J16, J17, J18, J19, J20, J21, J22, K16, K17, K18, K19, K21, E5, E6, F6, F9, G11, G12, G14, G15, G7, G8, G9, H10, H11, H12, H13, H14, H15, H8, H9, J10, J11, J12, J13, J14, J15, J9, K10, K12, K13, K14, K15

1. All grounds must be electrically connected at the board level.
2. NC pins should not be connected to any active signals, V_{CC} or GND.
3. Balls for GND, V_{CC} and V_{CCOx} are connected within the substrate to their respective common signals. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

ispXPGA Logic Signal Connections: 516-Ball fpBGA (Cont.)

516-Ball BGA Ball	LFX500			LFX200			LFX125		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
AJ13	BK2_IO32	-	58P	BK2_IO18	-	35P	BK2_IO18	-	31P
-	-	-	-	GND (Bank 2)	-	-	GND (Bank 2)	-	-
AK12	BK2_IO33	-	58N	BK2_IO19	-	35N	BK2_IO19	-	31N
AK13	BK2_IO34	-	59P	BK2_IO20	-	36P	BK2_IO20	-	32P
-	GND (Bank 2)	-	-	-	-	-	-	-	-
AH14	BK2_IO35	-	59N	BK2_IO21	-	36N	BK2_IO21	-	32N
AJ14	BK2_IO36	-	60P	BK2_IO22	-	37P	NC	-	-
AK14	BK2_IO37	-	60N	BK2_IO23	-	37N	NC	-	-
AG15	BK2_IO38	-	61P	BK2_IO24	-	38P	NC	-	-
AH15	BK2_IO39	-	61N	BK2_IO25	-	38N	NC	-	-
AJ15	BK2_IO40	-	62P	NC	-	-	NC	-	-
AK15	BK2_IO41	-	62N	NC	-	-	NC	-	-
-	GND (Bank 2)	-	-	GND (Bank 2)	-	-	-	-	-
-	GND (Bank 3)	-	-	GND (Bank 3)	-	-	-	-	-
AK16	BK3_IO0	-	63P	BK3_IO0	-	39P	BK3_IO0	-	33P
AJ16	BK3_IO1	-	63N	BK3_IO1	-	39N	BK3_IO1	-	33N
AH16	BK3_IO2	-	64P	BK3_IO2	-	40P	BK3_IO2	-	34P
AG16	BK3_IO3	-	64N	BK3_IO3	-	40N	BK3_IO3	-	34N
AK17	BK3_IO4	-	65P	BK3_IO4	-	41P	BK3_IO4	-	35P
AJ17	BK3_IO5	-	65N	BK3_IO5	-	41N	BK3_IO5	-	35N
AH17	BK3_IO6	-	66P	BK3_IO6	-	42P	BK3_IO6	-	36P
-	GND (Bank 3)	-	-	GND (Bank 3)	-	-	-	-	-
AJ18	BK3_IO7	-	66N	BK3_IO7	-	42N	BK3_IO7	-	36N
AH18	BK3_IO8	-	67P	BK3_IO8	-	43P	BK3_IO8	-	37P
-	-	-	-	-	-	-	GND (Bank 3)	-	-
AG18	BK3_IO9	-	67N	BK3_IO9	-	43N	BK3_IO9	-	37N
AK18	BK3_IO10	-	68P	BK3_IO10	-	44P	BK3_IO10	-	38P
AK19	BK3_IO11	-	68N	BK3_IO11	-	44N	BK3_IO11	-	38N
AJ19	BK3_IO12	-	69P	BK3_IO12	-	45P	NC	-	-
AH19	BK3_IO13	-	69N	BK3_IO13		45N	NC	-	-
AK20	BK3_IO14	-	70P	BK3_IO14	-	46P	NC	-	-
-	GND (Bank 3)	-	-	GND (Bank 3)	-	-	-	-	-
AJ20	BK3_IO15	-	70N	BK3_IO15	-	46N	NC	-	-
AH20	BK3_IO16	-	71P	NC	-	-	NC	-	-
AG20	BK3_IO17	-	71N	NC	-	-	NC	-	-
AK21	BK3_IO18	-	72P	NC	-	-	NC	-	-
AJ21	BK3_IO19	-	72N	NC	-	-	NC	-	-
AH21	BK3_IO20	VREF3	73P	BK3_IO16	VREF3	47P	BK3_IO12	VREF3	39P
AG21	BK3_IO21	-	73N	BK3_IO17	-	47N	BK3_IO13	-	39N
AJ22	BK3_IO22	-	74P	BK3_IO18	-	48P	BK3_IO14	-	40P
-	GND (Bank 3)	-	-	-	-	-	-	-	-
AH22	BK3_IO23	-	74N	BK3_IO19	-	48N	BK3_IO15	-	40N
AK23	BK3_IO24	-	75P	NC	-	-	NC	-	-
AJ23	BK3_IO25	-	75N	NC	-	-	NC	-	-
AH23	BK3_IO26	-	76P	NC	-	-	NC	-	-
AK24	BK3_IO27	-	76N	NC	-	-	NC	-	-
AJ24	BK3_IO28	-	77P	NC	-	-	NC	-	-
AG23	BK3_IO29	-	77N	NC	-	-	NC	-	-
AH24	BK3_IO30	-	78P	NC	-	-	NC	-	-
-	GND (Bank 3)	-	-		-	-	-	-	-
AK25	BK3_IO31	-	78N	NC	-	-	NC	-	-

ispXPGA Logic Signal Connections: 680-Ball fpBGA (Cont.)

LFX1200			
680-Ball fpBGA	**Signal Name**	**Second Function**	**LVDS Pair/sysHSI Reserved[1]**
C24	BK1_IO7	SS_CLKIN0N	34N
A22	BK1_IO8	-	35P
D22	BK1_IO9	-	35N
A23	BK1_IO10	-	36P
-	GND (Bank 1)	-	-
B25	BK1_IO11	-	36N
D23	BK1_IO12	PLL_RST2	37P
A24	BK1_IO13	PLL_RST3	37N
A25	BK1_IO14	-	38P
E24	BK1_IO15	-	38N
D24	BK1_IO16	-	39P
A26	BK1_IO17	-	39N
D25	BK1_IO18	-	40P
-	GND (Bank 1)	-	-
C25	BK1_IO19	-	40N
B26	BK1_IO20	-	41P/HSI3
B27	BK1_IO21	-	41N/HSI3
D26	BK1_IO22	-	42P/HSI3
A27	BK1_IO23	-	42N/HSI3
A28	BK1_IO24	-	43P/HSI3
E26	BK1_IO25	-	43N/HSI3
C27	BK1_IO26	HSI3A_SOUTP	44P/HSI3
-	GND (Bank 1)	-	-
D27	BK1_IO27	HSI3A_SOUTN	44N/HSI3
B28	BK1_IO28	-	45P/HSI3
A30	BK1_IO29	-	45N/HSI3
C28	BK1_IO30	HSI3A_SINP	46P/HSI3
D28	BK1_IO31	HSI3A_SINN	46N/HSI3
A31	BK1_IO32	-	47P/HSI3
B30	BK1_IO33	-	47N/HSI3
E28	BK1_IO34	HSI3B_SOUTP	48P/HSI3
-	GND (Bank 1)	-	-
D29	BK1_IO35	HSI3B_SOUTN	48N/HSI3
C29	BK1_IO36	-	49P/HSI4
B31	BK1_IO37	-	49N/HSI4
D30	BK1_IO38	HSI3B_SINP	50P/HSI4
E30	BK1_IO39	HSI3B_SINN	50N/HSI4
A32	BK1_IO40	-	51P/HSI4
C31	BK1_IO41	-	51N/HSI4
D31	BK1_IO42	HSI4A_SOUTP	52P/HSI4
-	GND (Bank 1)	-	-
C32	BK1_IO43	HSI4A_SOUTN	52N/HSI4
B32	BK1_IO44	-	53P/HSI4

ispXPGA Logic Signal Connections: 680-Ball fpBGA (Cont.)

LFX1200			
680-Ball fpBGA	Signal Name	Second Function	LVDS Pair/sysHSI Reserved[1]
AK2	BK6_IO23	-	197N
AK1	BK6_IO24	-	198P
AJ4	BK6_IO25	-	198N
AJ3	BK6_IO26	-	199P
-	GND (Bank 6)	-	-
AH4	BK6_IO27	-	199N
AH3	BK6_IO28	-	200P
AH2	BK6_IO29	-	200N
AH1	BK6_IO30	-	201P
AG4	BK6_IO31	-	201N
AF5	BK6_IO32	DATA7	202P
AG3	BK6_IO33	DATA6	202N
AG2	BK6_IO34	-	203P
-	GND (Bank 6)	-	-
AF4	BK6_IO35	-	203N
AF3	BK6_IO36	DATA5	204P
AG1	BK6_IO37	DATA4	204N
AE2	BK6_IO38	-	205P
AF1	BK6_IO39	-	205N
AF2	BK6_IO40	-	206P
AE1	BK6_IO41	-	206N
AE4	BK6_IO42	-	207P
-	GND (Bank 6)	-	-
AD4	BK6_IO43	-	207N
AD5	BK6_IO44	-	208P
AD3	BK6_IO45	-	208N
AD2	BK6_IO46	-	209P
AD1	BK6_IO47	-	209N
AC4	BK6_IO48	-	210P
AC3	BK6_IO49	-	210N
AC2	BK6_IO50	DATA3	211P
-	GND (Bank 6)	-	-
AC1	BK6_IO51	DATA2	211N
AB3	BK6_IO52	-	212P
AB4	BK6_IO53	-	212N
AB2	BK6_IO54	DATA1	213P
AB1	BK6_IO55	DATA0	213N
AA3	BK6_IO56	-	214P
AA4	BK6_IO57	-	214N
AA5	BK6_IO58	-	215P
-	GND (Bank 6)	-	-
AA2	BK6_IO59	-	215N
AA1	BK6_IO60	-	216P

ispXPGA Logic Signal Connections: 680-Ball fpBGA (Cont.)

LFX1200			
680-Ball fpBGA	Signal Name	Second Function	LVDS Pair/sysHSI Reserved[1]
Y5	BK6_IO61	-	216N
-	GND (Bank 6)	-	-
-	GND (Bank 7)	-	-
W3	BK7_IO0	-	217P
W1	BK7_IO1	-	217N
W2	BK7_IO2	-	218P
-	GND (Bank 7)	-	-
W4	BK7_IO3	-	218N
V1	BK7_IO4	-	219P
V2	BK7_IO5	-	219N
V3	BK7_IO6	-	220P
V4	BK7_IO7	-	220N
W5	BK7_IO8	-	221P
U1	BK7_IO9	-	221N
U2	BK7_IO10	-	222P
-	GND (Bank 7)	-	-
U3	BK7_IO11	-	222N
U4	BK7_IO12	-	223P
T1	BK7_IO13	-	223N
T2	BK7_IO14	-	224P
T3	BK7_IO15	-	224N
R1	BK7_IO16	-	225P
R2	BK7_IO17	-	225N
T4	BK7_IO18	-	226P
-	GND (Bank 7)	-	-
P1	BK7_IO19	-	226N
P2	BK7_IO20	-	227P
P3	BK7_IO21	-	227N
R4	BK7_IO22	-	228P
T5	BK7_IO23	-	228N
M1	BK7_IO24	-	229P
M2	BK7_IO25	-	229N
N3	BK7_IO26	-	230P
-	GND (Bank 7)	-	-
P4	BK7_IO27	-	230N
L1	BK7_IO28	-	231P
M3	BK7_IO29	-	231N
L2	BK7_IO30	-	232P
N4	BK7_IO31	-	232N
K1	BK7_IO32	-	233P
K2	BK7_IO33	-	233N
P5	BK7_IO34	-	234P
-	GND (Bank 7)	-	-

ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
AB1	BK1_IO35	HSI3B_SOUTN	48N/HSI3	NC	-	-
AC6	BK1_IO36	-	49P/HSI4	NC	-	-
AC5	BK1_IO37	-	49N/HSI4	NC	-	-
AC2	BK1_IO38	HSI3B_SINP	50P/HSI4	NC	-	-
AC1	BK1_IO39	HSI3B_SINN	50N/HSI4	NC	-	-
AC4	BK1_IO40	-	51P/HSI4	NC	-	-
AC3	BK1_IO41	-	51N/HSI4	NC	-	-
AD2	BK1_IO42	HSI4A_SOUTP	52P/HSI4	NC	-	-
-	GND (Bank 1)	-	-	-	-	-
AD1	BK1_IO43	HSI4A_SOUTN	52N/HSI4	NC	-	-
AD3	BK1_IO44	-	53P/HSI4	BK1_IO32	-	37P/HSI3
AD4	BK1_IO45	-	53N/HSI4	BK1_IO33	-	37N
AE2	BK1_IO46	HSI4A_SINP	54P/HSI4	BK1_IO34	-	38P
AE1	BK1_IO47	HSI4A_SINN	54N/HSI4	BK1_IO35	-	38N
AD5	BK1_IO48	-	55P/HSI4	BK1_IO25	-	33N
AD6	BK1_IO49	VREF1	55N/HSI4	BK1_IO24	VREF1	33P
AF2	BK1_IO50	HSI4B_SOUTP	56P/HSI4	BK1_IO26	HSI2B_SOUTP	34P
-	GND (Bank 1)	-	-	-	-	-
AF1	BK1_IO51	HSI4B_SOUTN	56N/HSI4	BK1_IO27	HSI2B_SOUTN	34N
AE3	BK1_IO52	-	57P	BK1_IO28	-	35P
AE4	BK1_IO53	-	57N	BK1_IO29	-	35N
AG1	BK1_IO54	HSI4B_SINP	58P	BK1_IO30	HSI2B_SINP	36P
-	-	-	-	GND (Bank 1)	-	-
AG2	BK1_IO55	HSI4B_SINN	58N	BK1_IO31	HSI2B_SINN	36N
AE5	BK1_IO56	-	59P	BK1_IO36	-	39P
AF4	BK1_IO57	-	59N	BK1_IO37	-	39N
AH1	BK1_IO58	-	60P	BK1_IO38	-	40P
-	GND (Bank 1)	-	-	GND (Bank 1)	-	-
AH2	BK1_IO59	-	60N	BK1_IO39	-	40N
AF3	BK1_IO60	-	61P	BK1_IO40	-	41P
AG3	BK1_IO61	-	61N	BK1_IO41	-	41N
AH4	TCK	-	-	TCK	-	-
AJ3	TMS	-	-	TMS	-	-
AK3	TOE	-	-	TOE	-	-
AG5	BK2_IO0	-	62P	BK2_IO0	-	42P
AH5	BK2_IO1	-	62N	BK2_IO1	-	42N
AJ4	BK2_IO2	-	63P	BK2_IO2	-	43P
-	GND (Bank 2)	-	-	GND (Bank 2)	-	-
AK4	BK2_IO3	-	63N	BK2_IO3	-	43N
AG6	BK2_IO4	-	64P	BK2_IO4	-	44P
AH6	BK2_IO5	-	64N	BK2_IO5	-	44N
AJ5	BK2_IO6	-	65P	BK2_IO6	-	45P

ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
AK5	BK2_IO7	-	65N	BK2_IO7	-	45N
AE7	BK2_IO8	-	66P	BK2_IO8	-	46P
AF7	BK2_IO9	-	66N	BK2_IO9	-	46N
AG7	BK2_IO10	-	67P	BK2_IO10	-	47P
-	GND (Bank 2)	-	-	GND (Bank 2)	-	-
AH7	BK2_IO11	-	67N	BK2_IO11	-	47N
AE8	BK2_IO12	VREF2	68P	BK2_IO21	VREF2	52N
AF8	BK2_IO13	-	68N	BK2_IO20	-	52P
AJ6	BK2_IO14	-	69P	BK2_IO12	-	48P
AK6	BK2_IO15	-	69N	BK2_IO13	-	48N
AG8	BK2_IO16	-	70P	BK2_IO14	-	49P
AH8	BK2_IO17	-	70N	BK2_IO15	-	49N
AJ7	BK2_IO18	-	71P	BK2_IO16	-	50P
-	GND (Bank 2)	-	-	-	-	-
AK7	BK2_IO19	-	71N	BK2_IO17	-	50N
AF9	BK2_IO20	-	72P	BK2_IO18	-	51P
-	-	-	-	GND (Bank 2)	-	-
AG9	BK2_IO21	-	72N	BK2_IO19	-	51N
AJ8	BK2_IO22	-	73P	NC	-	-
AK8	BK2_IO23	-	73N	NC	-	-
AD10	BK2_IO24	-	74P	NC	-	-
AE10	BK2_IO25	-	74N	NC	-	-
AJ9	BK2_IO26	-	75P	NC	-	-
-	GND (Bank 2)	-	-	-	-	-
AK9	BK2_IO27	-	75N	NC	-	-
AF10	BK2_IO28	-	76P	NC	-	-
AG10	BK2_IO29	-	76N	NC	-	-
AK10	BK2_IO30	-	77P	NC	-	-
AJ10	BK2_IO31	-	77N	NC	-	-
AE11	BK2_IO32	-	78P	NC	-	-
AF11	BK2_IO33	-	78N	NC	-	-
AG11	BK2_IO34	-	79P	NC	-	-
-	GND (Bank 2)	-	-	-	-	-
AH11	BK2_IO35	-	79N	NC	-	-
AE12	BK2_IO36	-	80P	NC	-	-
AF12	BK2_IO37	-	80N	NC	-	-
AJ11	BK2_IO38	-	81P	NC	-	-
AK11	BK2_IO39	-	81N	NC	-	-
AG12	BK2_IO40	-	82P	NC	-	-
AH12	BK2_IO41	-	82N	NC	-	-
AK12	BK2_IO42	-	83P	BK2_IO22	-	53P
-	GND (Bank 2)	-	-	-	-	-

ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
AJ18	BK3_IO14	-	100P	BK3_IO14	-	70P
-	-	-	-	GND (Bank 3)	-	-
AK18	BK3_IO15	-	100N	BK3_IO15	-	70N
AE18	BK3_IO16	-	101P	BK3_IO16	-	71P
AD18	BK3_IO17	-	101N	BK3_IO17	-	71N
AJ19	BK3_IO18	-	102P	BK3_IO18	-	72P
-	GND (Bank 3)	-	-	-	-	-
AK19	BK3_IO19	-	102N	BK3_IO19	-	72N
AH19	BK3_IO20	-	103P	NC	-	-
AG19	BK3_IO21	-	103N	NC	-	-
AK20	BK3_IO22	-	104P	NC	-	-
AJ20	BK3_IO23	-	104N	NC	-	-
AF19	BK3_IO24	-	105P	NC	-	-
AE19	BK3_IO25	-	105N	NC	-	-
AH20	BK3_IO26	-	106P	NC	-	-
-	GND (Bank 3)	-	-	-	-	-
AG20	BK3_IO27	-	106N	NC	-	-
AF20	BK3_IO28	-	107P	NC	-	-
AE20	BK3_IO29	-	107N	NC	-	-
AJ21	BK3_IO30	-	108P	NC	-	-
AK21	BK3_IO31	-	108N	NC	-	-
AG21	BK3_IO32	-	109P	NC	-	-
AF21	BK3_IO33	-	109N	NC	-	-
AK22	BK3_IO34	-	110P	NC	-	-
-	GND (Bank 3)	-	-	-	-	-
AJ22	BK3_IO35	-	110N	NC	-	-
AE21	BK3_IO36	-	111P	NC	-	-
AD21	BK3_IO37	-	111N	NC	-	-
AG22	BK3_IO38	-	112P	NC	-	-
AF22	BK3_IO39	-	112N	NC	-	-
AG23	BK3_IO40	-	113P	BK3_IO22	-	74P
-	-	-	-	GND (Bank 3)	-	-
AH23	BK3_IO41	-	113N	BK3_IO23	-	74N
AJ23	BK3_IO42	-	114P	BK3_IO24	-	75P
-	GND (Bank 3)	-	-	-	-	-
AK23	BK3_IO43	-	114N	BK3_IO25	-	75N
AF23	BK3_IO44	-	115P	BK3_IO26	-	76P
AE23	BK3_IO45	-	115N	BK3_IO27	-	76N
AJ24	BK3_IO46	-	116P	BK3_IO28	-	77P
AK24	BK3_IO47	-	116N	BK3_IO29	-	77N
AH24	BK3_IO48	-	117P	BK3_IO21	-	73N
AG24	BK3_IO49	VREF3	117N	BK3_IO20	VREF3	73P

ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
AJ25	BK3_IO50	-	118P	BK3_IO30	-	78P
-	GND (Bank 3)	-	-	GND (Bank 3)	-	-
AK25	BK3_IO51	-	118N	BK3_IO31	-	78N
AF24	BK3_IO52	-	119P	BK3_IO32	-	79P
AE24	BK3_IO53	-	119N	BK3_IO33	-	79N
AK26	BK3_IO54	-	120P	BK3_IO34	-	80P
AJ26	BK3_IO55	-	120N	BK3_IO35	-	80N
AH25	BK3_IO56	-	121P	BK3_IO36	-	81P
AG25	BK3_IO57	-	121N	BK3_IO37	-	81N
AK27	BK3_IO58	-	122P	BK3_IO38	-	82P
-	GND (Bank 3)	-	-	GND (Bank 3)	-	-
AJ27	BK3_IO59	-	122N	BK3_IO39	-	82N
AG26	BK3_IO60	-	123P	BK3_IO40	-	83P
AH26	BK3_IO61	-	123N	BK3_IO41	-	83N
AK28	GSR	-	-	GSR	-	-
AJ28	DXP	-	-	DXP	-	-
AH27	DXN	-	-	DXN	-	-
AG28	BK4_IO0	-	124P	BK4_IO0	-	84P
AF27	BK4_IO1	-	124N	BK4_IO1	-	84N
AF28	BK4_IO2	-	125P	BK4_IO2	-	85P/HSI3
-	GND (Bank 4)	-	-	GND (Bank 4)	-	-
AE26	BK4_IO3	-	125N	BK4_IO3	-	85N/HSI3
AE27	BK4_IO4	-	126P	BK4_IO4	-	86P/HSI3
AE28	BK4_IO5	-	126N	BK4_IO5	-	86N/HSI3
AH30	BK4_IO6	HSI5A_SINP	127P	BK4_IO10	HSI3A_SINP	89P/HSI3
-	-	-	-	GND (Bank 4)	-	-
AH29	BK4_IO7	HSI5A_SINN	127N	BK4_IO11	HSI3A_SINN	89N/HSI3
AD25	BK4_IO8	-	128P	BK4_IO12	-	90P/HSI3
AD26	BK4_IO9	-	128N	BK4_IO13	-	90N/HSI3
AG29	BK4_IO10	HSI5A_SOUTP	129P/HSI5	BK4_IO14	HSI3A_SOUTP	91P/HSI3
-	GND (Bank 4)	-	-	-	-	-
AG30	BK4_IO11	HSI5A_SOUTN	129N/HSI5	BK4_IO15	HSI3A_SOUTN	91N/HSI3
AD27	BK4_IO12	VREF4	130P/HSI5	BK4_IO17	VREF4	92N/HSI3
AD28	BK4_IO13	-	130N/HSI5	BK4_IO16	-	92P/HSI3
AF29	BK4_IO14	HSI5B_SINP	131P/HSI5	BK4_IO6	-	87P/HSI3
AF30	BK4_IO15	HSI5B_SINN	131N/HSI5	BK4_IO7	-	87N/HSI3
AC25	BK4_IO16	-	132P/HSI5	BK4_IO8	-	88P/HSI3
AC26	BK4_IO17	-	132N/HSI5	BK4_IO9	-	88N/HSI3
AE29	BK4_IO18	HSI5B_SOUTP	133P/HSI5	NC	-	-
-	GND (Bank 4)	-	-	-	-	-
AE30	BK4_IO19	HSI5B_SOUTN	133N/HSI5	NC	-	-
AC28	BK4_IO20	-	134P/HSI5	NC	-	-

Revision History (Cont.)

Date	Version	Change Summary
June 2004 (cont.)	08.0 (cont.)	Updated Global Clock Input Setup time specifications.
		Clarification of Serial Out LVDS test condition.
		Clarification of REFCLK, SS_CLKIN peak-to-peak period jitter condition.
		Added sysHSI Reserved pins and footnote.
		Removed industrial ordering part numbers.
July 2004	09.0	Added “E” Series product family.
August 2004	10.0	Final release.
December 2004	10.1	Updated NC Connections table.
April 2005	10.2	Clarification of IDK specification.
April 2005	11.0	Select lead-free packages release.
July 2005	12.0	Added lead-free 516 fpBGA ordering part numbers.
April 2007	13.0	Removed lead-free 680 fpSBGA information from Part Number Description and Ordering Part Number tables. Removed lead-free 516 fpBGA for LFX125 from Ordering Part Number tables.
November 2007	14.0	Removed lead-free 516 fpBGA information from Part Number Description and Ordering Part Number tables.
July 2008	14.1	Added 516 fpBGA package without heat spreader to Part Number Description and Ordering Part Number tables.
February 2010	15.0	Ordering part numbers and ispXPGA Family Selection Guide table have been updated per PCN #03A-10 (discontinuation of the ispXPGA 1200 devices).
		References to "system gates" changed to "functional gates."